Electronic Patent	App	lication Fee	Transm	ittal			
Application Number:	108	10812354					
Filing Date:	30-	30-Mar-2004					
Title of Invention:	Me dep	Method of improving the wafer to wafer uniformity and defectivity of a deposited dielectric film					
First Named Inventor/Applicant Name:	No	Noriaki Fukiage					
Filer:	Jan	James Klekotka					
Attorney Docket Number:	071	071469-0308969 (FKL-020)					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			490